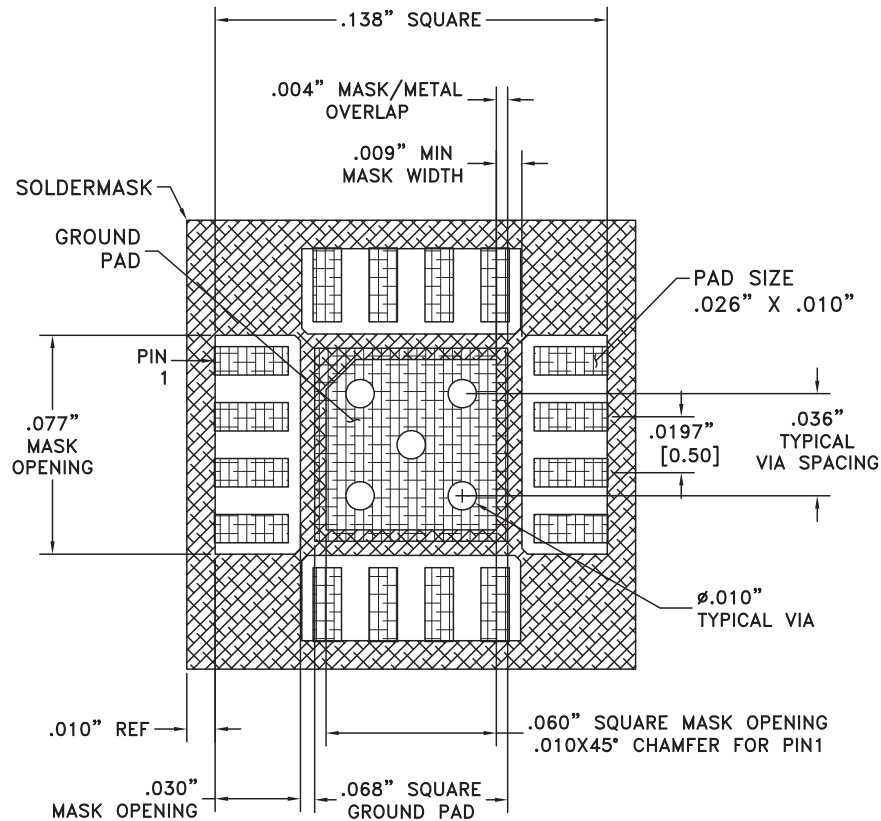
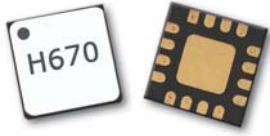


**LC3C – 3 x 3 mm QFN CERAMIC  
HIGH FREQUENCY SMT PACKAGE**

**Suggested LC3C PCB Land Pattern**



**NOTES:**

1. DIMENSIONS ARE IN INCHES [MILLIMETERS].
2. PAD WIDTH SHOWN IS FOR SOLDERING ONLY. BEYOND SOLDERING AREA ALL CONDUCTORS THAT CARRY RF AND MICROWAVE SIGNALS SHOULD HAVE 50 OHM CHARACTERISTIC IMPEDANCE.

